



P.C.B. LAYOUT
TOP VIEW ±0.05

MATERIALS

HOUSING: HI-TEMP. PLASTIC (UL 94V-0), BLACK
 SHELL: STAINLESS STEEL
 PAD: COPPER ALLOY, TIN PLATED
 TERMINAL: COPPER ALLOY, GOLD PLATED

SPECIFICATION

CURRENT RATING: 0.5AMP MAX
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 80m OHMS MAX
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
 OPERATION TEMPERATURE: -20°C~+60°C

PART NUMBER:

4MCKF - 0 8 * * - 1 2 0

SERIES
 NO. OF POS.
 CONTACT PLATED OPTION
 SOLDER TAIL PLATING OPTION
 TAPE REEL PACKAGE

1: GOLD FLASH
 3: 3u" GOLD
 5: 5u" GOLD

BLANK: GOLD FLASH
 T: TIN PLATING

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TOLERANCES		MEMORY CARD SERIES				
X.X ±0.3	TITLE	MICRO SD (T-FLASH), PCB MOUNT, SMT, METAL SHIELD, FEMALE, HINGE TYPE				
X.XX ±0.2		DRAWN BY	CHECKED BY	APPROVED BY		
X.XXX ±0.1		Janice	Lion	Benson		
Angle ±5°	UNIT	SCALE	SIZE	DRAW NO.	REV.	Sheet
		10056	MM	NONE	A4	4MCKF-001

A	RELEASE	2011.8.2
REV.	DESCRIPTION	DATE